

# **3A STEP-DOWN PWM CONVERTER**

### **■ FEATURES**

- Operating Input Voltage From 4.5V to 24V
- 3.3V, 5V, 12V and Adjustable Output Version
- Adjustable Version Output Voltage Range, 1.25V to 24V  $\pm$  4% max Over Line and Load Regulation
- Available in TO-263-5, TO-220-5, TO-220B and TO-252-5 Package
- Requires Only 4 External Components.
- 150KHz Fixed Constant Frequency
- Low Power Standby Mode, I<sub>Q</sub> Typically 80μA
- . TTL Shutdown Capability.
- Current Limit and Thermal Shutdown Protection.
- 3A Guaranteed Output Load Current

# APPLICATIONS

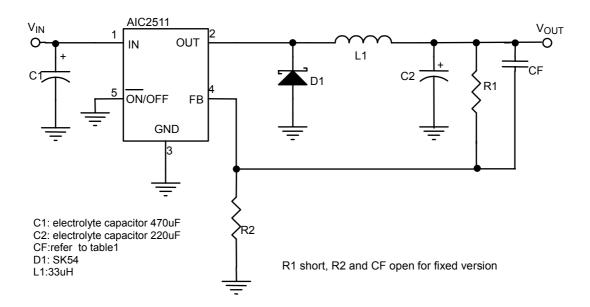
- Fixed Voltage power supply for LCD Monitor and LCD TV
- · On-Card Switching regulators
- Simple High Efficiency Step-down regulator

### GENERAL DESCRIPTION

The AIC2511 series are step-down monolithic PWM converters for delivering 3A at fixed voltages of 3.3V, 5.0V, 12V and using an external divider to adjust output voltage from 1.25V to 24V with excellent line and load regulation.

Switching frequency up to 150KHz is achievable thus allowing smaller-sized filter components. Internal current limit and thermal shutdown circuits provide protection from overloads. The internal precise reference combined with voltage feedback loop provides optimum output voltage accuracy and fast load transient response.

### ■ TYPICAL APPLICATION CIRCUIT



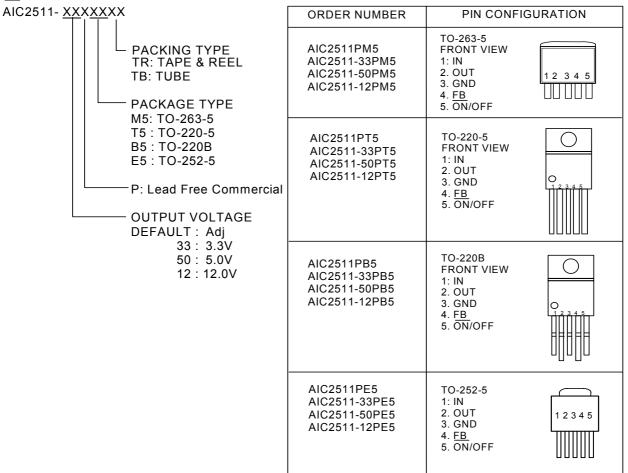
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DS-2511P-02 071607

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# ORDERING INFORMATION



Example: AIC2511-50PM5TR

→ 5.0V Output Version, in Lead Free TO-263-5 Package & Taping & Reel Packing Type

AIC2511-33PB5TR

→ 3.3V Output Version, in Lead Free TO-220B Package & Taping & Reel Packing Type



# ■ ABSOLUTE MAXIMUM RATINGS

Supply Voltage		24V
FB, ON/OFF Pin Input Voltage		-0.3V to 24V
Operating Temperature Range		-40°C ~ 85°C
Storage Temperature Range		<b>–</b> 65°C ~ 150°C
Junction Temperature		125°C
Lead Temperature (Soldering 10sec.)		260°C
Thermal Resistance Junction to Case	TO-263-5, TO-220-5, TO-220B	3°C /W
	TO-252-5	12.5°C /W
Thermal Resistance Junction to Ambient	TO-263-5	60°C /W
(Assume no ambient airflow, no heatsink)	TO-220-5, TO-220B	50°C /W
	TO-252-5	100°C /W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.



# **ELECTRICAL CHARACTERISTICS** ( $T_A=25^{\circ}$ C, $V_{IN}=12$ V for the 3.3V, 5V and Adjustable version and $V_{IN}=24$ V for the 12V version.) (Note1)

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Input Voltage		4.5		24	V
Fixed Output Voltage	AIC2511-ADJ (V <sub>IN</sub> > 4.5V)	1.193		1.267	V
	AIC2511-33 (V <sub>IN</sub> > 4.75V)	3.168		3.432	V
	AIC2511-50 (V <sub>IN</sub> > 7.0V)	4.800		5.200	V
	AIC2511-12 (V <sub>IN</sub> > 15V)	11.52		12.48	V
Saturation Voltage			1.2	1.4	V
Output Voltage Regulation				4	%
Quiescent Current	Internal switch off		5	10	mA
Shutdown Quiescent Current	ON/OFF= 5V (OFF)		80	200	μА
FB bias current	V <sub>FB</sub> =1.3		10	50	nA
Output leakage current	Vout=-0.9		2	30	mA
Logic Input High	(Regulator OFF)	2.0			V
Logic Input Low	(Regulator ON)			0.6	V
Oscillator Frequency		130	150	180	KHz
Output Current Limit		3.6		5.5	Α
Maximum Duty Cycle		100			%
Minimum Duty Cycle			0		%
Efficiency	Vo=5V, Io=3A		80		%

**Note 1:** Specifications are production tested at T<sub>A</sub>=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).



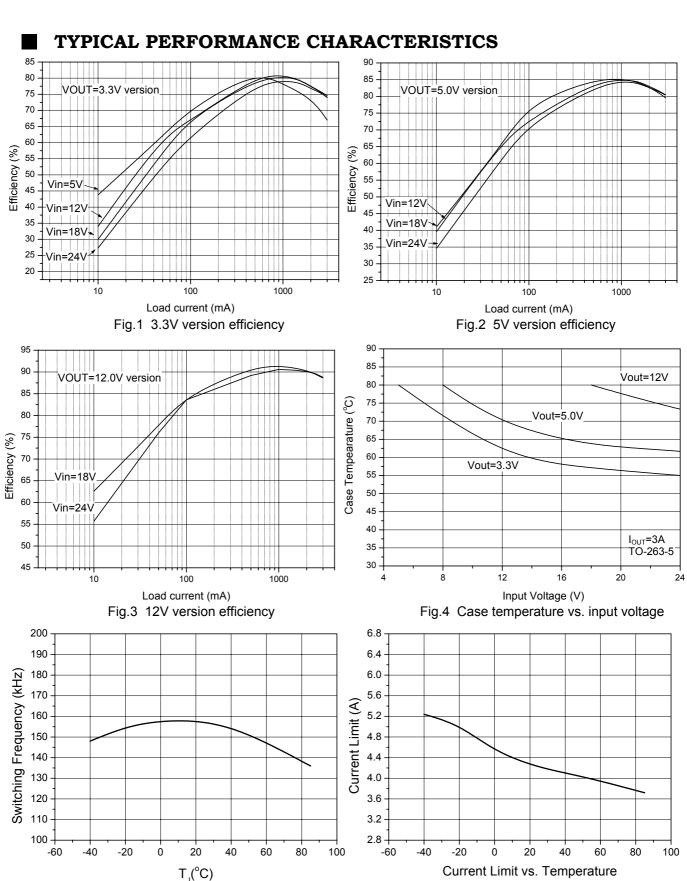
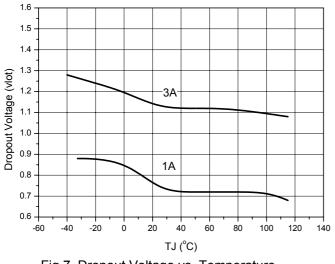


Fig.5 Switching Frequency vs. Temperature

Fig.6 Current Limit vs. Temperature



# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



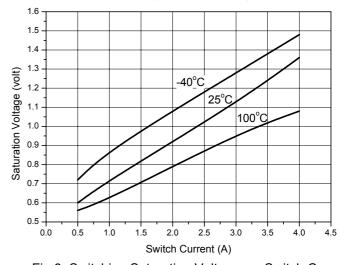


Fig.7 Dropout Voltage vs. Temperature

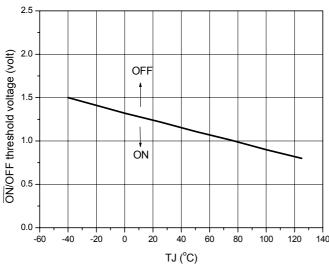


Fig.8 Switching Saturation Voltage vs. Switch Current

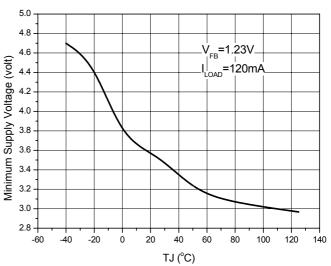


Fig.9 ON/OFF Threshold Voltage vs. Temperature

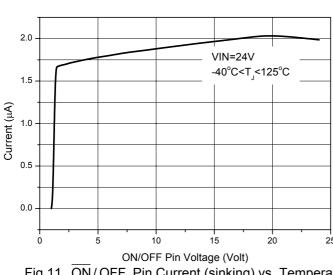


Fig.10 Minimum Operating Supply Voltage vs. Temperature (ADJ only)

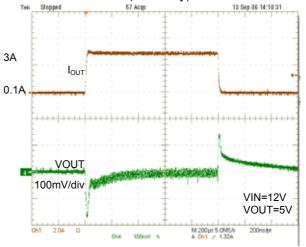
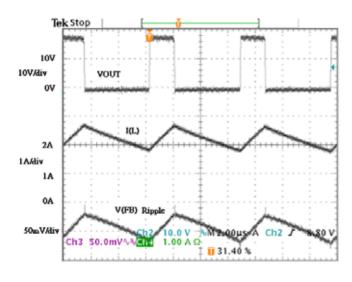


Fig.11 ON/OFF Pin Current (sinking) vs. Temperature

Fig.12 Load transient response



# ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





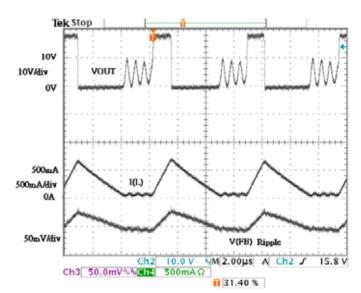
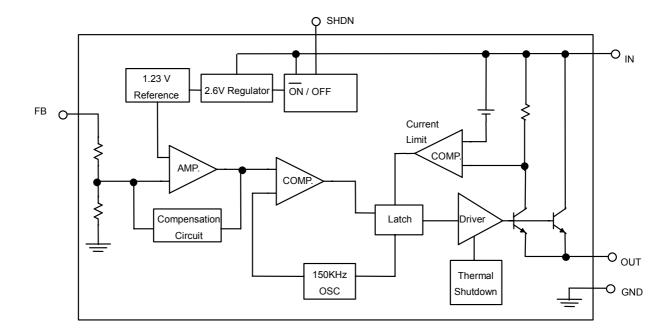


Fig.14 FB Pin Ripple(DCM)

# BLOCK DIAGRAM





## ■ PIN DESCRIPTIONS

PIN 1: IN Supply voltage input for the IC

switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the

regulator.

PIN 2: OUT Internal switch. The voltage at this

pin switches between  $(V_{IN}-V_{SAT})$  and approximately -0.5V, with a duty cycle of approximately

 $V_{OUT}/V_{IN}$ .

PIN 3: GND Ground requires a short, low noise

connection to ensure good load

regulation.

PIN 4: FB Feedback input for fixed-output or

adjustable-output version. Connect directly to output for fixed operation version or to a resistor

divider for adjustable operation

versions.

PIN 5: ON/OFF Allows the switching regulator

circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately  $80\mu A$ . Drive it high to disable the reference, control

circuitry and internal switches. Drive low or connect to GND for

normal operation.

# APPLICATION INFORMATION

#### Thermal considerations

The AIC2511 is available with TO-220-5, TO-220B, TO-263-5 and TO-252-5 packages. The TO-220-5 and TO-220B packages need a heat sink in most conditions. The TO-263-5 and TO-252-5 packages are designed to be soldered to the copper on a printed circuit board. The printed circuit board is the heat sink for TO-263-5 and TO-252-5 packages and other heat components, such as inductors and diodes. The size of the heat sink depends on the power loss of AIC2511 and the ambient temperature. The power loss of AIC2511 is determined by input voltage, output voltage and load current. The Fig.4 represents the curve of the AIC2511 case temperature in different conditions.

The curve shows the AIC2511 temperature rises above ambient temperature for a 3A load with different input and output voltage. The values of

the temperature rise, which are affected by factors such as sink size, heat produced from heat components, and etc., may be different from those in Fig.8 depending on the conditions of the application. According to the equation 1, as the power loss or ambient temperature is rising the heat sink size must be increased to decrease the thermal resistance (  $R\theta_{jA}$  ) so that the junction temperature does not over 125 C. An appropriate increase of heat sink size may result in a normal-ranged junction temperature.

$$P_D = \frac{T_j - T_A}{R\theta_{iA}}$$

As junction temperature rises to its temperature protect point, the AIC2511 will stop working. Output voltage drops to zero until the junction temperature decreases to a normal range.



# APPLICATION INFORMATION (Continued)

## **Components Selection**

#### Inductor

The inductor selection depends on the operating frequency of the AIC2511. The ripple current  $\Delta I_L$  interrelates with inductor value. A lower inductor value gets a higher ripple current. Besides, a higher  $V_{IN}$  or  $V_{OUT}$  can also get the same result. The inductor value can be calculated as the following formula.

$$L = \frac{1}{(f)(\Delta I_L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Users can define the acceptable  $\Delta I_L$  to gain a suitable inductor value.

#### Diode

The diode current rating must be higher than 1.3 times maximum load current. Also, if the power supply needs to resist a continuous output short, the diode should have a current ration equal to the maximum current limit of the AlC2511. The reverse voltage rating of the diode should be higher than 1.25 times input voltage and the diode must be fast. The reverse recovery time of the diode is short.

#### Capacitor

The selection of output capacitor depends on the suitable ripple voltage. Lower ripple voltage corresponds to lower ESR (Equivalent Series Resistor) of output capacitor. Typically, once the ESR is satisfied with the ripple voltage, the value of capacitor is adequate for filtering. The formula of ripple voltage is as below:

$$\Delta V_{OUT} = \Delta I_{L} \left( ESR + \frac{1}{8fC_{OUT}} \right)$$

The typical input capacitor is 470uF. But as the temperature decreases, the input capacitor needs to increase to stabilize the circuit.

Assume the input voltage is 12V, output voltage is 5V and maximum load current is 3A. The output ripple must be smaller than 2% of output voltage

Inductor selection

$$L = \frac{1}{(f)(\Delta I_L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$
$$= \frac{1}{150k \times 0.6} \times 5 \times \left( 1 - \frac{5}{12} \right) = 32.4uH$$

Here, the delta  $I_L$  is 0.6A. So we choose 33uH inductor.

Output capacitor selection

$$\Delta V_{OUT} = \Delta I_L \left( ESR + \frac{1}{8fC_{OUT}} \right) < 100mV$$

We choice the capacitor value: ESR=0.12, capacitance=220uF

$$\Rightarrow \Delta V_{OUT} = \Delta I_L \left( ESR + \frac{1}{8fC_{OUT}} \right) = 74mV < 100mV$$

The full load is 3A and delta  $I_L$  is 0.6A, so the diode current rating must be higher than 3.6A.

#### CF Capacitor for adj version

As using the AIC2511 adj version, the CF capacitor is required to provide additional stability. In different condition, the CF capacitor must be changed to make the circuit stable.

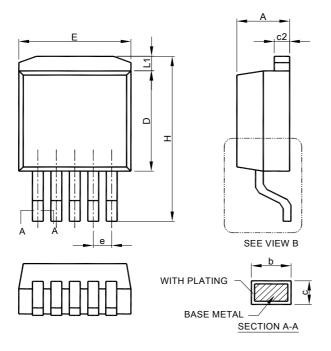
Output	Input	R1	R2	CF
Voltage (V)	Voltage (V)	$(\Omega)$	$(\Omega)$	(pF)
1.8	7	36k	82k	1000
4	12	180k	82k	360
6	12	180k	47k	360
8	15	180k	33k	360
10	18	150k	22k	470
15	25	110k	10k	560

Table 1

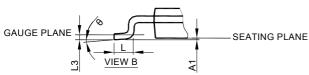


# ■ PHYSICAL DIMENSIONS (unit: mm)

### ● TO-263-5



S	TO-2	63-5L
S Y M B	MILLIMETERS	
O L	MIN.	MAX.
Α	4.06	4.83
A1	0.00	0.25
b	0.51	0.99
С	0.38	0.74
c2	1.14	1.65
D	8.38	9.65
Е	9.65	10.67
е	1.70 BSC	
Н	14.61	15.88
L	1.78	2.79
L1		1.68
L3	0.25 BSC	
q	0°	8°



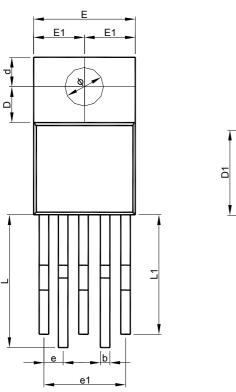
### Note: 1. Refer to JEDEC TO-263BA.

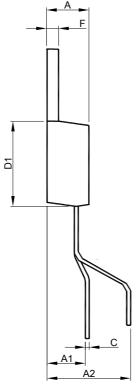
- 2. Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
- 3. Dimension "D" does not include inter-lead flash or protrusions.
- 4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



# ■ PHYSICAL DIMENSIONS(Continued) (unit: mm)

# ● TO-220B





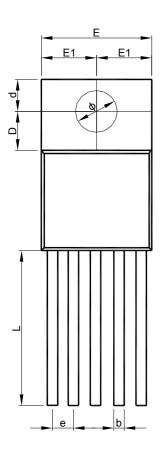
_		
S Y	TO-2	20B
M B O	MILLIM	IETERS
O L	MIN.	MAX.
Α	4.318	4.826
A1	4.250	4.550
A2	8.250	8.550
b	0.690	0.940
С	0.304	0.530
D	3.556(REF)	
D1	8.480	9.300
d	2.743(REF)	
Е	9.906	10.44
E1	4.953	5.220
Ø	3.708	3.962
е	1.524	2.032
e1	6.604	7.112
F	1.143	1.397
L	9.880	10.64
L1	9.090	9.850

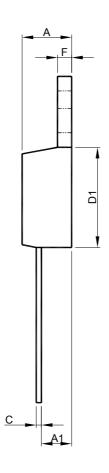
Note: Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



# ■ PHYSICAL DIMENSIONS(Continued) (unit: mm)

# ● TO-220-5L





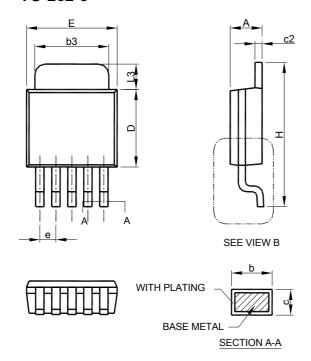
S Y	TO-2	20-5L
M B O	MILLIMETERS	
O L	MIN.	MAX.
Α	4.064	4.826
A1	2.032	2.921
b	0.635	1.016
С	0.304	0.460
D	3.429	3.683
D1	7.620	9.398
d	2.620	2.870
Е	9.779	10.668
E1	4.953	5.220
Ø	3.708	3.962
е	1.524	2.032
F	1.143	1.397
L	13.589	14.351

Note: Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

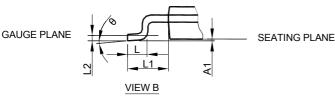


# ■ PHYSICAL DIMENSIONS(Continued) (unit: mm)

### ● TO-252-5



S	TO-2	52-5L	
S Y B O L	MILLIMETERS		
O L	MIN.	MAX.	
Α	2.19	2.38	
A1	0.00	0.13	
b	0.51	0.71	
b3	4.32	5.46	
С	0.46	0.61	
c2	0.46	0.89	
D	5.33	6.22	
Е	6.35	6.73	
е	1.27 BSC		
Н	9.40	10.41	
L	1.40	1.78	
L1	2.67 REF		
L2	0.51 BSC		
L3	0.89	2.03	
θ	0°	8°	



Note: 1. Refer to JEDEC TO-252AD and AB.

- 2. Dimension "E" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3. Dimension "D" does not include inter-lead flash or protrusions.
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